

RoHS

COMPLIANT

# 4426M-VB Datasheet N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
30	0.004 at V <sub>GS</sub> = 10 V	18	6.8 nC		
	0.005 at V <sub>GS</sub> = 4.5 V	16	0.0110		

SO-8

Top View

8 D

D

6 D

5 D

S

S

S

G

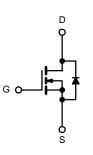
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#### FEATURES

- Halogen-free
- Trench Power MOSFET
- Optimized for High-Side Synchronous Rectifier Operation
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested

#### **APPLICATIONS**

Notebook CPU Core
High-Side Switch



N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b>	S T <sub>A</sub> = 25 °C, unles	s otherwise no	ted		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	30	- V	
Gate-Source Voltage		V <sub>GS</sub>	± 20		
	T <sub>C</sub> = 25 °C		18		
Continuous Drain Current (T. $-150$ °C)	T <sub>C</sub> = 70 °C		16		
Continuous Drain Current ( $T_J = 150 \ ^{\circ}C$ )	T <sub>A</sub> = 25 °C	I <sub>D</sub> –	15 <sup>b, c</sup>	٨	
	T <sub>A</sub> = 70 °C		13 <sup>b, c</sup>		
Pulsed Drain Current		I <sub>DM</sub>	50	A	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	1	3.8		
	T <sub>A</sub> = 25 °C	I <sub>S</sub> –	2.1 <sup>b, c</sup>		
Single Pulse Avalanche Current		I <sub>AS</sub>	22		
Avalanche Energy	nergy L = 0.1 mH		24	mJ	
	T <sub>C</sub> = 25 °C		4.5		
Maximum Davias Disaination	T <sub>C</sub> = 70 °C	Б	2.8	14/	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>b, c</sup>	W	
	T <sub>A</sub> = 70 °C		1.6 <sup>b, c</sup>		
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, d</sup>	$t \le 10 \text{ s}$	R <sub>thJA</sub>	38	50	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	22	28	0/11	

Notes:

a. Base on T<sub>C</sub> = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s. d. Maximum under Steady State conditions is 85 °C/W.



Symbol V <sub>DS</sub> ΔV <sub>DS</sub> /T <sub>J</sub>	Test Conditions	Min.	Тур.	Max.	Unit	
			1	1	1	
$\Lambda V_{DQ}/T$	$V_{GS} = 0 V, I_{D} = 250 \mu A$	30			V	
	I <sub>D</sub> = 250 μA		28		mV/°C	
$\Delta V_{GS(th)}/T_J$	2		- 6			
V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1.0		3.0	V	
I <sub>GSS</sub>	$V_{DS} = 0 V$ , $V_{GS} = \pm 20 V$			± 100	nA	
lago	$V_{DS} = 30 V, V_{GS} = 0 V$			1		
USS	$V_{DS}$ = 30 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C			10	μΑ	
I <sub>D(on)</sub>	$V_{DS} \ge 5$ V, $V_{GS}$ = 10 V	20			А	
Р	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 11 A	0.004				
RDS(on)	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 10 A		0.005		Ω	
g <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 11 A		52		S	
C <sub>iss</sub>			820		pF	
	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		195			
			73			
	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 11 \text{ A}$		15	23		
Qg			6.8	10.2	nC	
Q <sub>gs</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 5 V, I <sub>D</sub> = 11 A		2.5			
Q <sub>qd</sub>			2.3			
R <sub>q</sub>	f = 1 MHz	0.36	1.8	3.6	Ω	
			16	24	-	
t <sub>r</sub>	$V_{DD} = 15 \text{ V}, \text{ R}_{1} = 1.4 \Omega$		12	18		
t <sub>d(off)</sub>	$I_D \cong 9 \text{ A}, V_{GEN} = 4.5 \text{ V}, \text{ R}_g = 1 \Omega$		16	24		
t <sub>f</sub>			10	20		
t <sub>d(on)</sub>			8	16	ns	
t <sub>r</sub>	$V_{DD} = 15 V, R_1 = 1.4 \Omega$		10	20	-	
t <sub>d(off)</sub>	$I_D \cong 9 \text{ A}, V_{GEN} = 10 \text{ V}, \text{R}_q = 1 \Omega$		16	24		
	Ŭ		8	15		
I . I	T <sub>C</sub> = 25 °C			25		
I <sub>SM</sub>				50	A	
-	I <sub>S</sub> = 9 A		0.8	1.2	V	
	-		15	30	ns	
			-	12	nC	
	I <sub>F</sub> = 9 A, dl/dt = 100 A/µs, T <sub>J</sub> = 25 °C		8		-	
					ns	
	I <sub>GSS</sub> I <sub>DSS</sub> I <sub>D(on)</sub> R <sub>DS(on)</sub> gfs       C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> Qg       Qgs       Qgd       Rg       t <sub>d(on)</sub> t <sub>f</sub> t <sub>d(off)</sub> t <sub>f</sub> t <sub>d(off)</sub> t <sub>f</sub> t <sub>d(off)</sub> t <sub>f</sub> t <sub>d(off)</sub> t <sub>f</sub>	$\begin{array}{c c c c c c c c } I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} = \pm 20 \ V \\ \hline & V_{DS} = 30 \ V, \ V_{GS} = 0 \ V, \ T_J = 55 \ ^{\circ}C \\ \hline & V_{DS} = 30 \ V, \ V_{GS} = 0 \ V, \ T_J = 55 \ ^{\circ}C \\ \hline & V_{DS} = 30 \ V, \ V_{GS} = 10 \ V \\ \hline & V_{GS} = 10 \ V, \ I_D = 11 \ A \\ \hline & V_{GS} = 4.5 \ V, \ I_D = 10 \ A \\ \hline & V_{DS} = 15 \ V, \ I_D = 11 \ A \\ \hline & V_{DS} = 15 \ V, \ I_D = 11 \ A \\ \hline & V_{DS} = 15 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ \hline & C_{rss} \\ \hline & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 11 \ A \\ \hline & Q_{gd} \\ \hline & Q_{gd} \\ \hline & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 11 \ A \\ \hline & Q_{gd} \\ \hline & R_{g} \qquad f = 1 \ MHz \\ \hline & t_{d(on)} \\ t_{f} \\ \hline & t_{d(onf)} \\ t_{f} \\ \hline & t_{d(off)} \\ \hline & t_{f} \\ \hline & t_{f} \\ \hline & t_{SM} \\ \hline & V_{SD} \qquad I_{S} = 9 \ A \\ \hline & V_{SD} \qquad I_{S} = 9 \ A \\ \hline & t_{rr} \\ \hline & Q_{rr} \\ \hline & t_{g} \\ \hline & I_{F} = 9 \ A, \ dI/dt = 100 \ A/\mus, \ T_{J} = 25 \ ^{\circ}C \\ \hline & t_{a} \\ \hline & V_{SD} \ & V_{S} = 0 \ A \\ \hline & A$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	

Notes:

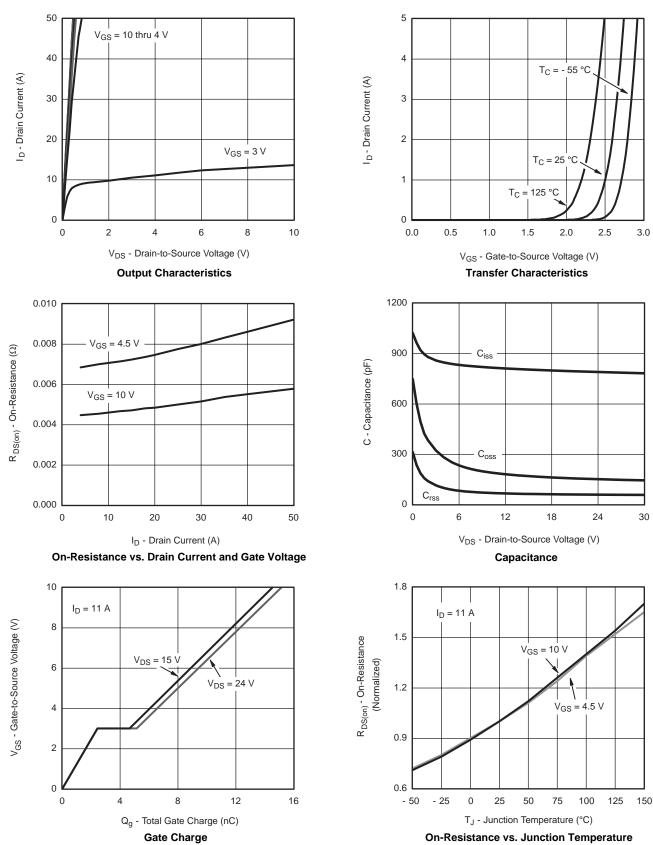
a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

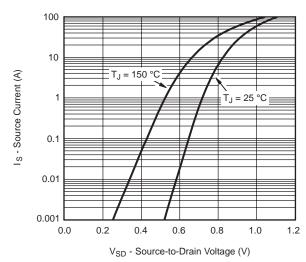




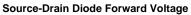


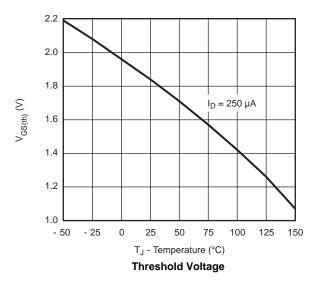
服务热线:400-655-8788

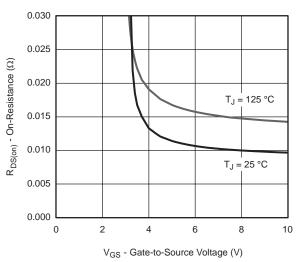




#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



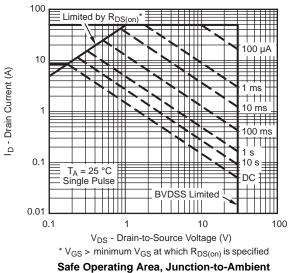




On-Resistance vs. Gate-to-Source Voltage

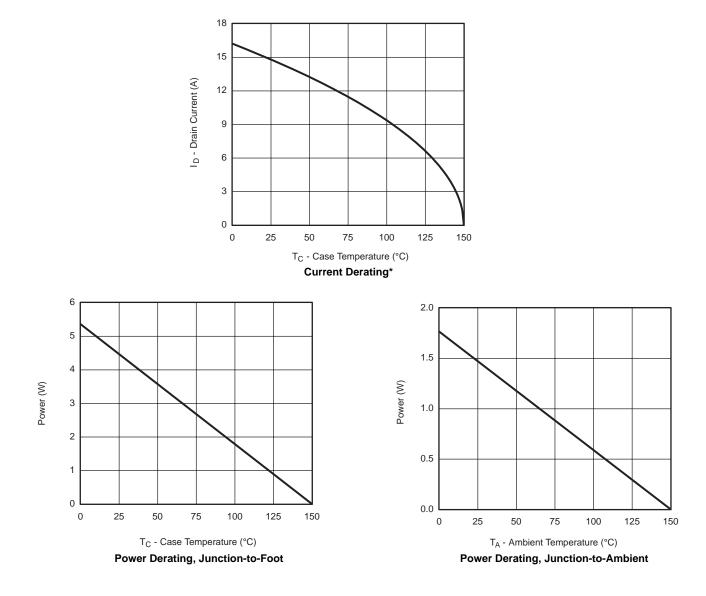




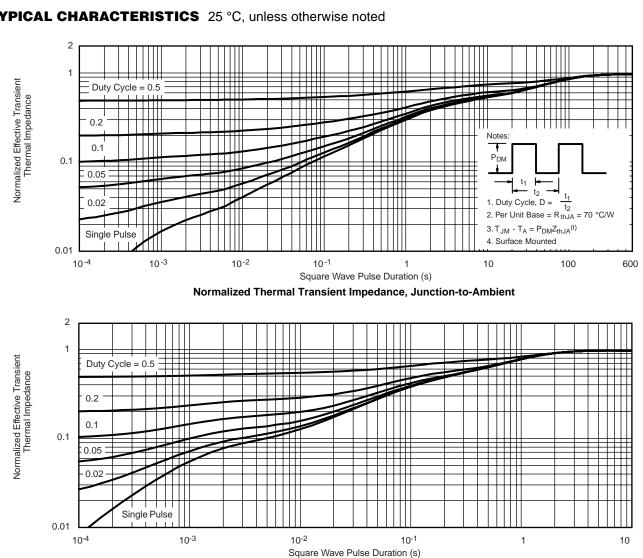




### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Normalized Thermal Transient Impedance, Junction-to-Foot

Bsemi

www.VBsemi.com



## SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

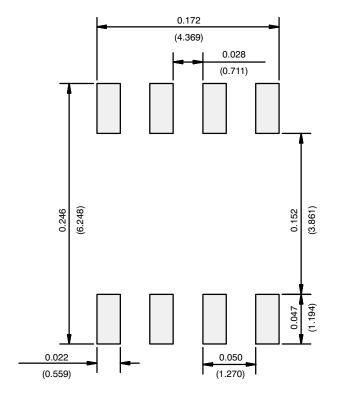




	MILLIMETERS		INC	CHES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
e	1.27 BSC		0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					



## **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)



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